



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| V _{(BR)DSS} | R _{DS(ON)} | I _D T _A = +25 <i>°</i> C |
|----------------------|-------------------------------|---|
| 60V | 1.8Ω @ $V_{GS} = 10V$ | 440mA |
| 60 V | 2.1Ω @ $V_{GS} = 4.5V$ | 410mA |

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- **DC-DC Converters**
- **Power Management Functions**

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

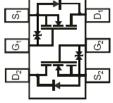
- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram Below
- Weight: 0.006 grams (Approximate)

SOT563









Top View

Bottom View

Top View Pin Definition/Schematic

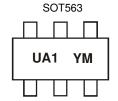
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|--------|---------------------|
| DMG1026UV-7 | SOT563 | 3,000 / Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



UA1 = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: X = 2010)

M = Month (ex: 9 = September)

Date Code Key

| Year | 2009 | | 2010 | 2011 | | 2012 | 2013 | | 2014 | 2015 | | 2016 |
|-------|------|-----|------|------|-----|------|------|-----|------|------|-----|------|
| Code | W | | Χ | Υ | | Z | Α | | В | С | | D |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



| Character | Symbol | Value | Unit | | |
|--|------------------|--|----------------|------------|----|
| Drain-Source Voltage | V _{DSS} | 60 | V | | |
| Gate-Source Voltage | V _{GSS} | ±20 | V | | |
| Continuous Drain Current (Note 5) V _{GS} = 10V | Steady State | T _A = +25 °C T _A = +85 °C | I _D | 410 300 | mA |
| Continuous Drain Current (Note 6) V _{GS} = 10V | t ≤ 10s | T _A = +25 °C T _A = +85 °C | I _D | 440 320 | mA |
| Continuous Drain Current (Note 5) V _{GS} = 4.5V | Steady State | T _A = +25 °C T _A = +85 °C | I _D | 380 270 | mA |
| Continuous Drain Current (Note 6) V _{GS} = 4.5V | t ≤ 10s | T _A = +25 °C T _A = +85 °C | ID | 410 295 | mA |
| Pulsed Drain Current (Note 7) | I _{DM} | 1.0 | Α | | |

Thermal Characteristics

| Characteristic | Symbol | Max | Unit |
|---|-----------------------------------|-------------|------|
| Power Dissipation (Note 5) | P _D | 0.58 | W |
| Thermal Resistance, Junction to Ambient @T _A = +25 °C (Note 5) | R _{0JA} | 213 | °C/W |
| Power Dissipation (Note 6) t ≤ 10s | P _D | 0.65 | W |
| Thermal Resistance, Junction to Ambient @T _A = +25 °C (Note 6) t ≤ 10s | $R_{\theta JA}$ | 192 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | ℃ |

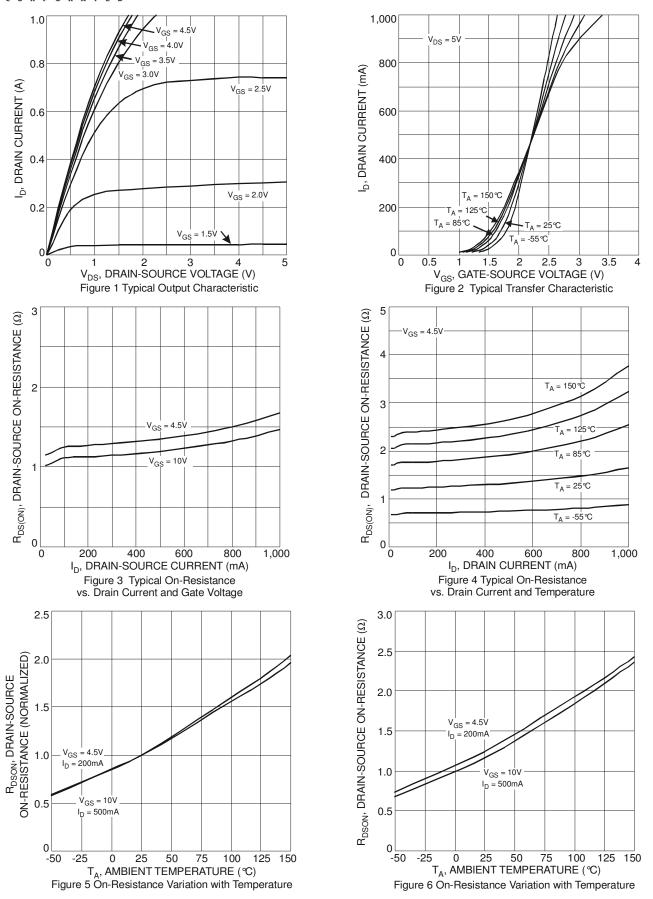
Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---|----------------------|-----|------|------|------|---|--|
| OFF CHARACTERISTICS (Note 8) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ | |
| Zero Gate Voltage Drain Current T _J = +25℃ | I _{DSS} | _ | _ | 1.0 | μΑ | $V_{DS} = 50V, V_{GS} = 0V$ | |
| Gate-Source Leakage | | _ | | ±50 | nA | $V_{GS} = \pm 5V$, $V_{DS} = 0V$ | |
| Gale-Source Leakage | I _{GSS} | | | ±150 | nA | $V_{GS} = \pm 10V$, $V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 8) | | | | | | • | |
| Gate Threshold Voltage | V _{GS(th)} | 0.5 | _ | 1.8 | V | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | |
| Static Drain-Source On-Resistance | | _ | 1.2 | 1.8 | Ω | V _{GS} = 10V, I _D = 500mA | |
| Static Drain-Source On-nesistance | R _{DS} (ON) | | 1.4 | 2.1 | Ω | V _{GS} = 4.5V, I _D = 200mA | |
| Forward Transfer Admittance | Y _{fs} | 80 | 580 | _ | mS | V _{DS} = 10V, I _D = 200mA | |
| Continuous Source Current (Note 8) | Is | _ | | 200 | mA | - | |
| Diode Forward Voltage | V _{SD} | _ | 0.8 | 1.3 | V | V _{GS} = 0V, I _S = 200mA | |
| DYNAMIC CHARACTERISTICS (Note 9) | | | | | | • | |
| Input Capacitance | C _{iss} | _ | 32 | _ | | | |
| Output Capacitance | Coss | _ | 4.4 | _ | pF | $V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | _ | 2.9 | _ | | 1 – 1.000112 | |
| Gate Resistance | R_g | _ | 126 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Total Gate Charge | Qg | _ | 0.45 | _ | | V 45V V 10V | |
| Gate-Source Charge | Q _{gs} | _ | 0.08 | _ | рС | $V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$ | |
| Gate-Drain Charge | Q _{gd} | _ | 0.08 | | | ID = 250IIIA | |
| Turn-On Delay Time | t _{D(on)} | _ | 3.4 | | ns | 101/1/ 001/ | |
| Turn-On Rise Time | t _r | _ | 3.4 | _ | ns | $V_{GS} = 10V, V_{DS} = 30V,$ | |
| Turn-Off Delay Time | t _{D(off)} | _ | 26.4 | _ | ns | $R_L = 150\Omega$, $R_G = 25\Omega$, | |
| Turn-Off Fall Time | t _f | _ | 16.3 | _ | ns | $I_D = 200 \text{mA}$ | |

Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 PCB with minimum recommended pad layout, measured in t ≤ 10s.
- 7. Repetitive rating, pulse width limited by junction temperature, $10\mu s$ pulse, duty cycle = 1%.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.







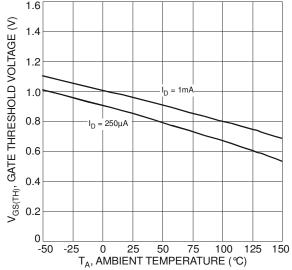
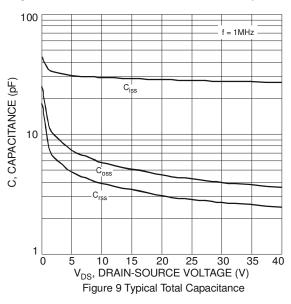
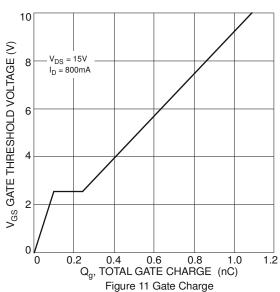
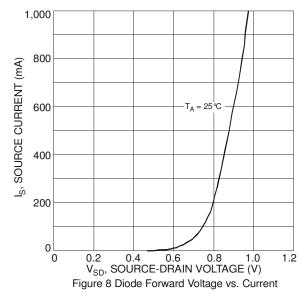
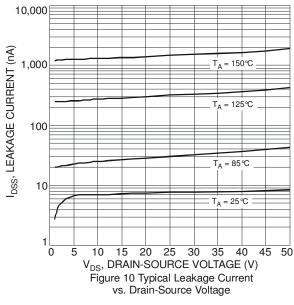


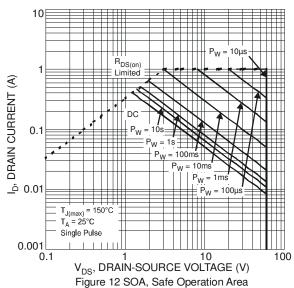
Figure 7 Gate Threshold Variation vs. Ambient Temperature



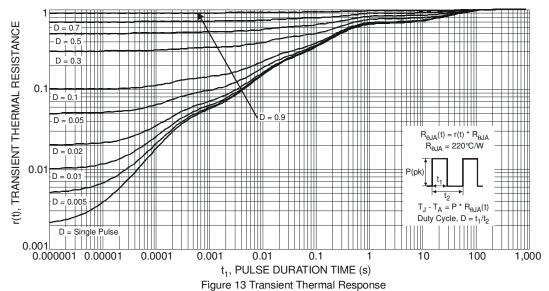








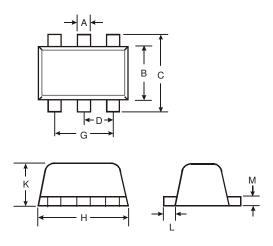




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Package Outline Dimensions

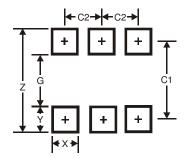
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| SOT563 | | | | | | |
|----------------------|------|------|------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 0.15 | 0.30 | 0.20 | | | |
| В | 1.10 | 1.25 | 1.20 | | | |
| С | 1.55 | 1.70 | 1.60 | | | |
| D | - | - | 0.50 | | | |
| G | 0.90 | 1.10 | 1.00 | | | |
| Н | 1.50 | 1.70 | 1.60 | | | |
| K | 0.55 | 0.60 | 0.60 | | | |
| L | 0.10 | 0.30 | 0.20 | | | |
| М | 0.10 | 0.18 | 0.11 | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) | | |
|------------|---------------|--|--|
| Z | 2.2 | | |
| G | 1.2 | | |
| Х | 0.375 | | |
| Υ | 0.5 | | |
| C1 | 1.7 | | |
| C2 | 0.5 | | |



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